

Inductors for power circuits

Size 4.2 x 4.2 x 4.2 (mm)

Series/Type: CLT42
Status: Preliminary

Date: June 2025

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Preliminary



Important information

This series is not yet released for mass production and subject to change. The products delivered are engineering samples, prototypes or pre-series products, which are not intended for commercial use in series products of the purchaser. The supplier assumes no warranty or liability. Any use is at the sole risk of the purchaser.

Rated inductance 32 ... 225 nH Typical saturation current 48.1 ... 124 A

Construction

- Thick copper frame
- Molded metal solution
- No internal connection



- High current, low DC resistance
- Temperature range from -40 °C up to +165 °C incl. self-heating
- ESD tested up to 2 kV to AEC-Q200 (planned)
- Suitable for lead-free reflow soldering as referenced in JEDEC J-STD 020F
- Qualified according to AEC-Q200 (planned)
- RoHS-compatible

Applications

■ PMIC systems in automotive electronics

Terminals

- Tinned terminals
- Layer composition Ni, SnBi3
- Lead-free tinned

Marking

- No marking on component
- Minimum data on reel:
 Manufacturer, ordering code, lot number, quantity, date of packing

Delivery mode and packing unit

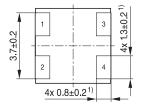
- 12-mm blister tape, wound on 330-mm Ø reel
- Packing unit: 1500 pcs./reel



Size 4.2 x 4.2 x 4.2 (mm)

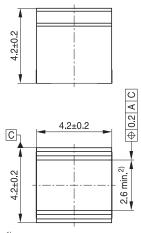
Preliminary

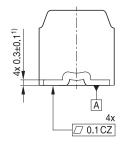
Dimensions



Circuit Diagram

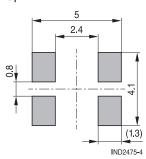




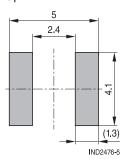


Layout recommendation

Option 1



Option 2



¹⁾ Soldering area 2) Suction area



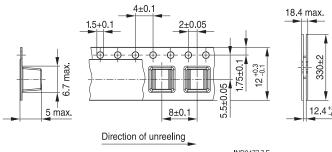
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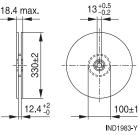
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Taping and packing

Blister tape



Reel



IND2477-7-E



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Technical data and measuring conditions

Rated inductance L _R	Measured with Agilent 4990A at 1 MHz, 0.1 V, +23 $^{\circ}$ C ± 3 $^{\circ}$ C			
Inductance tolerance	±20% at +23 °C ±3 °C			
Operating temperature range	−40 °C +165 °C			
Rated current I _{temp}	Based on the temperature increase (temperature increase 40 K by self-heating) Ambient temperature: +23 °C ±3 °C			
CLT42-32N:	Measured in 1000 μm Cu thickness single layer			
CLT42-90N to CLT42R22:	Measured in 105 μm Cu thickness single layer			
	PCB 100 x 40 x 1 mm (equivalent to multilayer PCB) Temperature rise is highly dependent on many factors and consequently, it must be verified in final application			
Saturation current I _{sat}	Based on the inductance change rate (30% below the initial value)			
DC resistance R _{DC}	Measured at +23 °C ±3 °C; tolerance ±15%			
Solderability (lead-free)	Sn96.5Ag3.0Cu0.5: +245 °C / 5 s Method: Solder bath (Dip) Wetting of soldering area: ≥ 95%			
Resistance to soldering heat	+260 °C, 40 s (as referenced in JEDEC J-STD 020F)			
Climatic category	40/165/56 (to IEC 60068-1)			
Storage conditions	Mounted: -40 °C +165 °C Packaged: -25 °C +40 °C, ≤ 75% RH			
Weight	440 mg			

Characteristics and ordering codes

L _R	R _{DC,typ}	I _{Sat,typ} at 23 °C	Itemp,typ at 23 °C at +40 K temp. increase	Internal code	Ordering code
nΗ	mΩ	Α	A		
32	0.20	124.0	75.0	B82404T0320M000	CLT42-32N
90	0.76	96.3	32.4	B82404T0900M000	CLT42-90N
120	0.76	68.6	32.4	B82404T0121M000	CLT42-R12
170	1.70	67.1	21.7	B82404T0171M000	CLT42-R17
225	1.70	48.1	21.7	B82404T0221M000	CLT42-R22



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Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition), online catalogs and in the data sheets
 - Particular attention should be paid to the derating curves, if given, Derating applies in the case the ambient temperature in application exceeds the rated temperature of the component.
 - Ensure the operation temperature of the component in application not to exceed the maximum specified value or the upper climatic category temperature.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. It is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
 - Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g., ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted, sealed, or varnished in customer applications:
 - Many potting, sealing, or varnishing materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting, sealing or varnishing materials used attack or destroy the wire insulation, plastics, or glue.
 - The effect of the potting, sealing, or varnishing materials may change the high-frequency behavior of the components.
 - Many coating materials have a negative effect (chemically and mechanically) on the winding wires, insulation materials and connecting points. Customers are always obligated to determine whether and to what extent their coating materials influence the component.
 - Customers are responsible and bear all risk for the use of the coating material. TDK Electronics does not assume any liability for failures of our components that are caused by the coating material.
- Magnetic core materials such as ferrites are sensitive to direct impact. This can cause the core material to flake or lead to breakage of the magnetic core material.
- Any type of tension or pressure on the product may result in damage and affect its functionality and reliability.
 - The products are only to be attached to fixing or mounting holes provided for this purpose in accordance with the data sheet.
 - If additional mechanical forces are applied to the component, e.g., application of gap pads, it is necessary to check whether they attack or destroy any part of the component.
 - It is not permitted for the product specified in the data sheet to assume a mechanical function in the final application.
- Inductance value can drop if external metallic or magnetic parts will be put close to the coil or into the air gap of the coil or core or magnetic material.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.
- Due to product design and applied manufacturing process, appearance, symmetry, and shape of not dimensioned details could vary within same lot, as well discoloration of housing is possible. TDK does not expect detrimental effects on product function or reliability. In case of conflicts. TDK reference standard shall prevail.



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Cautions and warnings

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- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
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- 3. The warnings, cautions and product-specific notes must be observed.
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Important notes

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